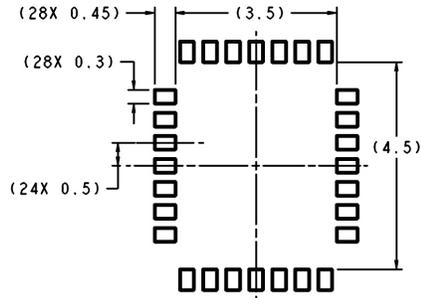
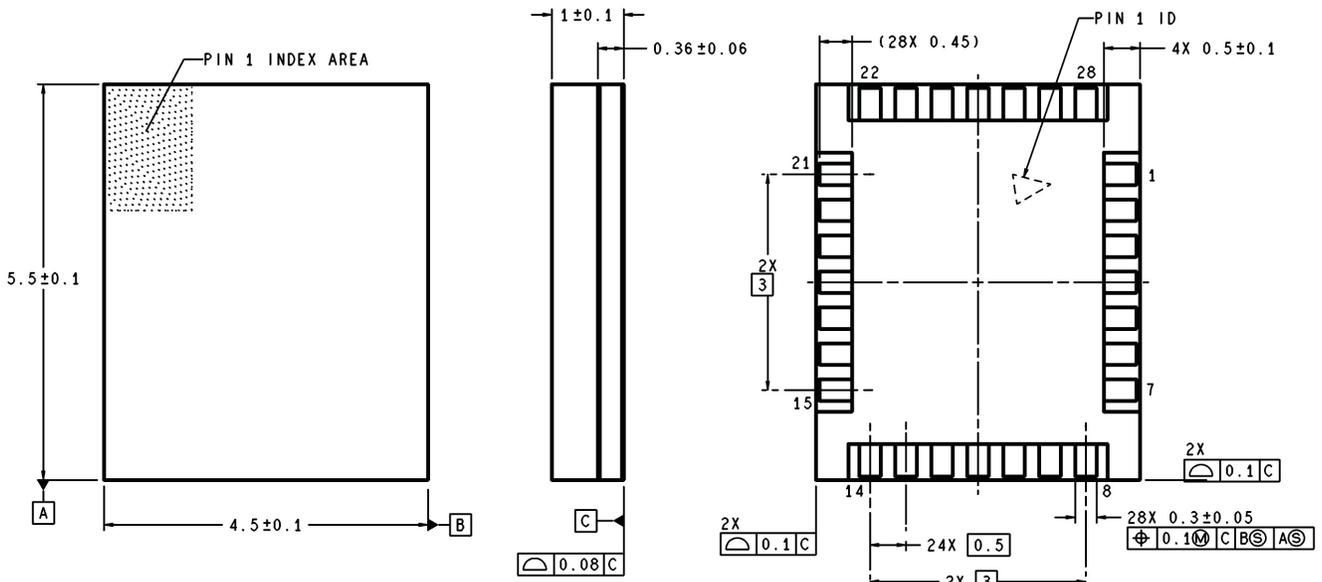


NPK0028A



RECOMMENDED LAND PATTERN
1:1 RATIO WITH PACKAGE SOLDER PADS



DIMENSIONS ARE IN MILLIMETERS

SLB28A (Rev B)

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